

Title (en)

COMPOSITION FOR SINTERING COMPRISING AN ORGANIC SILVER PRECURSOR AND PARTICLES OF AGGLOMERATED SILVER NANOPARTICLES

Title (de)

ZUSAMMENSETZUNG ZUM SINTERN MIT EINEM ORGANISCHEN SILBERVORLÄUFER UND PARTIKEL VON AGGLOMERIERTEN SILBER-NANOPARTIKELN

Title (fr)

COMPOSITION POUR FRITTAGE COMPRENNANT UN PRÉCURSEUR D'ARGENT ORGANIQUE ET DES PARTICULES DE NANOParticules D'ARGENT AGGLOMÉRÉES

Publication

**EP 4249148 A1 20230927 (EN)**

Application

**EP 22163294 A 20220321**

Priority

EP 22163294 A 20220321

Abstract (en)

The present invention relates to a composition that is suitable for joining two components by sintering. The composition comprises an organic silver precursor as defined herein and particles that have an average size of  $\leq 20 \mu\text{m}$  and that comprise agglomerated silver nanoparticles. The ratio of the weight of the silver precursor to the weight of the particles is  $\leq 0.25$ .

IPC 8 full level

**B22F 1/054** (2022.01); **B22F 1/0545** (2022.01); **B22F 1/107** (2022.01); **B22F 9/24** (2006.01); **B22F 9/30** (2006.01); **B22F 7/06** (2006.01)

CPC (source: EP)

**B22F 1/0545** (2022.01); **B22F 1/056** (2022.01); **B22F 1/107** (2022.01); **B22F 9/30** (2013.01); **B22F 7/064** (2013.01); **B22F 9/24** (2013.01)

Citation (applicant)

- EP 2838690 B1 20190717 - NANO JOIN GMBH [DE]
- EP 2159270 A1 20100303 - BAYER MATERIALSCIENCE AG [DE]
- DE 102009040076 A1 20110310 - HERAEUS GMBH W C [DE]
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Citation (search report)

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Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

BA ME

Designated validation state (EPC)

KH MA MD TN

DOCDB simple family (publication)

**EP 4249148 A1 20230927**

DOCDB simple family (application)

**EP 22163294 A 20220321**